LA9605W



MD Player RF and Matrix Signal-Processing IC

Overview

The LA9605W integrates MiniDisk playback functions, including servo error signal generation, RF signal processing, and wobble signal binarization output on a single chip. The LA9605W, when combined with an LC89640, can implement a complete MD player system.

Features

- Allows the servo error signal level to be set to an arbitrary level using a VCA circuit.
- Few peripheral components required.
- Ultraminiature package

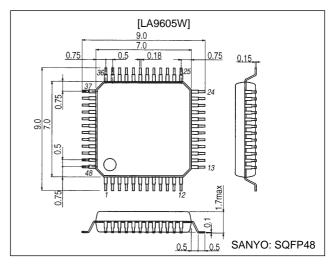
Functions

- Servo signal I-V conversion amplifier
- Pit/groove switching RF amplifier
- RF equalizer amplifier
- Servo signal VCA
- APC circuit
- Focus error amplifier
- Tracking error amplifier
- HFL circuit
- Defect detection circuit
- ADIP amplifier
- Pre-pit circuit (pit/groove discrimination circuit)
- ADIPCR

Package Dimensions

unit: mm

3163A-SQFP48



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Specifications Maximum Ratings at $Ta = 25^{\circ}C$

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V _{CC} max		7	V
Allowable power dissipation	Pd max	When mounted on a 114.3 \times 76.1 \times 1.6-mm single-sided glass-epoxy printed circuit board. Ta \leq 75 °C	350	mW
Operating temperature	Topr		-25 to +75	°C
Storage temperature	Tstg		-40 to +150	°C

Operating Conditions at $Ta = 25^{\circ}C$

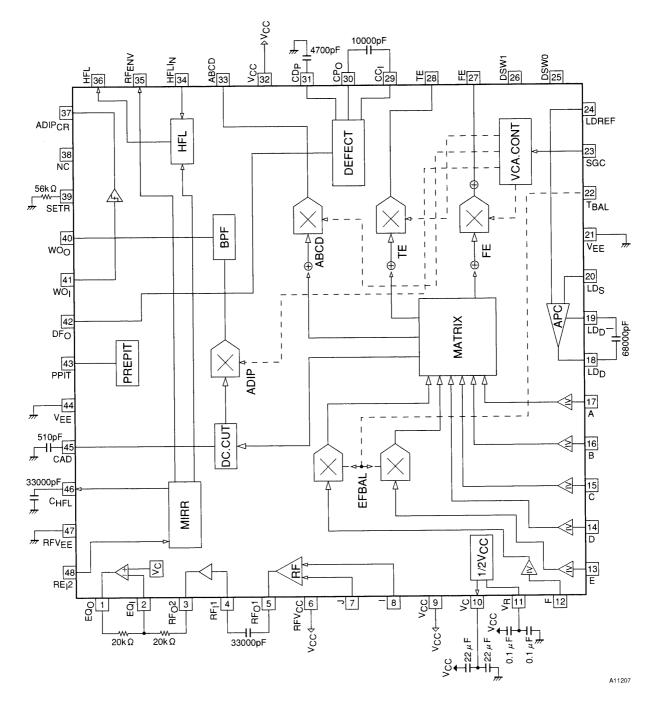
Parameter	Symbol	Conditions	Ratings	Unit
Recommended supply voltage	V _{CC}		5	V
Operating supply voltage range	V _{CC} op		2.7 to 5.5	V

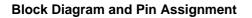
Electrical Characteristics at Ta = 25° C, V_{CC} = 5 V

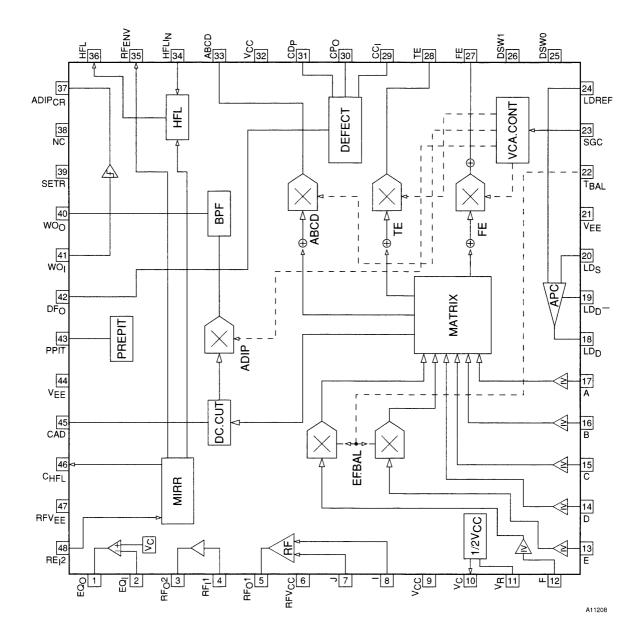
Doromot	or	Symbol	Conditions		Ratings		Unit
Parameter		Symbol	Conditions	min	typ	max	Unit
Current drain		I _{CC}		18	32	46	mA
[RF AMP GROVE]							
Gain		VG _{RFMG} 1	$EQ_O/I: J = V_C$	27	30	33	dB
[RF AMP MO.PIT]				·			
Offset		V _{OS RFMP} 1	$RF_01: I = J = V_C$	V _C – 245	V _C – 185	V _C – 125	mV
Gain		VG _{RFMP} 1	$EQ_O/I: I = J$	15	18	21	dB
[RF AMP AL]							
Offset		V _{OS RFAP} 1	$RF_01: I = J = V_C$	V _C – 152	V _C - 92	V _C - 32	mV
Gain		VG _{RFAP} 1	$EQ_O/I: I = J = V_C$	5.5	8.5	11.5	dB
[RF AMP]				·			
Output level H		V _{ORFH} 1	$EQ_0 : RFI1 = V_C + 1 V$	3.5	4.1		V
		V _{ORFL} 1	$EQ_0 : RFI1 = V_C - 1 V$		0.9	1.5	V
[ABCD GR]	·			·			
Gain		VG _{ABG} 1	ABCD/A (10 kHz) : A = B = C = D, SGC = 0.78 V	17.5	20.5	23.5	dB
Outrast Jassal	Н	V _{OABGH} 2	ABCD : A = B = C = D = V _C - 400 mV, SGC = 0.78 V	4.5	4.9		V
Output level	L	V _{OABGL} 2	ABCD : A = B = C = D = V _C + 400 mV, SGC = 0.78 V		0.1	0.5	V
[ABCD PIT]							
Gain		VG _{ABP} 1	ABCD/A (10 kHz) : A = B = C = D, SGC = 0.3 V	10.6	13.6	16.6	dB
Frequency characte	ristics	V∆G _{ABP} 1	ABCD/A (10 kHz) – ABCD/A (35 kHz), SGC = 0.3 V	3.9	6.9	9.9	dB
[FOCS]							
Outrast laws	Н	V _{OFOH} 1	FE : B = D = V_C + 825 mV, A = C = V_C , SGC = 0.3 V	4.5	4.9		V
Output level	L	V _{OFOL} 1	FE : B = D = $V_C - 825 \text{ mV}$, A = C = V_C , SGC = 0.3 V		0.1	0.5	V
Gain		V _{GFO} 1	FE/A (5 kHz) : A = -B = C = -D, SGC = 0.3 V	13.9	16.9	19.9	dB
Frequency characteristics		V∆ _{GFO} 1	FE/A (5 kHz) – FE/A (26 kHz) : A = –B = C = –D, SGC = 0.3 V	0.4	3.4	6.4	dB
[TE GR]						1	
	Н	V _{OTEGH} 1	TE : $F = V_{C} + 200 \text{ mV}$, $E = V_{C}$, SGC = 0.78 V	4.5	4.9		V
Output level	L	V _{OTEGL} 1	TE : F = $V_C - 200 \text{ mV}$, E = V_C , SGC = 0.78 V		0.1	0.5	V
		VG _{TEG} 1	TE/E (5 kHz) : E = –F, SGC = 0.78 V	31.4	34.4	37.4	dB
Frequency characteristics VAGTEG		V∆G _{TEG} 1	TE/E (5 kHz) – TE/E (38 kHz) : E = –F, SGC = 0.78 V	1.8	4.8	8.8	dB
[TE PIT]						1	
		VG _{TEP} 1	TE/E (5 kHz) : E = -F, SGC = 0.3 V	25.2	28.2	31.2	dB
Frequency characte	ristics	V∆G _{TEP} 1	TE/E (5 kHz) – TE/E (38 kHz) : E = –F, SGC = 0.3 V	1.8	4.8	8.8	dB
[ADIP]						1	
Outrust In	Н	V _{OADH} 1	$CAD : A = D = V_{C} + 0.4 V, B = C = V_{C}$	1.4	1.7	2.0	V
Output level	L	V _{OADL} 1	$CAD : A = D = V_C - 0.4 V, B = C = V_C$	3.1	3.3	3.6	V

Doromotor		Sumbol	Conditions		Ratings		Unit
Parameter		Symbol	Conditions	min	typ	max	Unit
[APC LDON]							
Output level	н	V _{OLH} 1	$LD_D : LD_{REF} = 0 V, LD_S = 1 V$	3.7	4.2	4.7	V
Oulput level	L	V _{OLL} 1	$LD_D : LD_{REF} = 1 V, LD_S = 0 V$	0.3	0.8	1.3	V
[APC LDOFF]							
Off voltage		V _{OLOF} 1	$LD_D : LD_{REF} = 1 V, LD_S = 0 V$	3.7	4.2	4.7	V
[HFL]							
Output level	Н	V _{OHFLH} 1	$HFL : HFL_{IN} = V_C - 0.1 V$	4.6	4.8		V
Output level	L	V _{OHFLL} 1	HFL : HFL _{IN} = V _C		0.2	0.4	V
[DEFCT]							
Output level	Н	V _{ODEFH} 1	DFO : CC _I = 1.5 V	4.6	4.9		V
Output level	L	V _{ODEFL} 1	$DFO : CC_1 = OPEN, A = B = C = D = V_C - 200 \text{ mV}$		0.1	0.4	V
[VC reference voltage]							
		VO _{SC}	V _C :	2.35	2.5	2.65	V
		VO _{CLSO}	$V_{C}: V_{C} - 1 \text{ mA}$	2.35	2.5	2.65	V
		VO _{CLSI}	V _C : V _C + 1 mA	2.35	2.5	2.65	V
[PREPIT MO]				•			
High-level output volta	ge	VO _{PPH} 1	PPIT : I = J = 200 kHz (95 mVp-p + V _C + 0.125 V)	4.6	4.8		V
Low-level output voltage	ge	VO _{PPL} 1	PPIT : I = J = 30 kHz (95 mVp-p + V _C + 0.125 V)		0.2	0.4	V
High/low level switching time		DTPP1	PPIT : I = J = 200 kHz to 30 kHz	70	150	230	
		DIFFI	(95 mVp-p + V _C + 0.125 V)	70	150	230	μs
[BPF]			1		1		
Gain		VG _{BF} 1	WO _{O/A} (22.05 kHz) : A = -B = -C = D, SGC = 0.3 V	23.8	26.8	29.8	dB
Filter characteristics		VG _{BF} 2	VG _{BF1} /VG _{BF2} : (16 kHz), SGC = 0.3 V	0.8	4.8	9.8	dB
		VG _{BF} 3	VG _{BF1} /VG _{BF3} : (30 kHz), SGC = 0.3 V	0.4	4.4	9.4	dB
[I – V]							-
IV voltage A		ΔV_{RA}	Α : V (–1 μΑ) – V (–2 μΑ)	70	100	130	mV
IV voltage B		ΔV_{RB}	B : V (–1 µA) – V (–2 µA)	70	100	130	mV
IV voltage C		ΔV_{RC}	C : V (–1 µA) – V (–2 µA)	70	100	130	mV
IV voltage D		ΔV_{RD}	D : V (–1 µA) – V (–2 µA)	70	100	130	mV
IV voltage E ΔV_{RE}		ΔV_{RE}	Ε : V (–1 μΑ) – V (–2 μΑ)	70	100	130	mV
IV voltage F ΔV _{RF}		ΔV_{RF}	F : V (–1 µA) – V (–2 µA)	70	100	130	mV
$Ta = 25^{\circ}C, V_{CC} = 2.7 V$							
[FOCS]							
Offset		V _{OSFO} 1	FE : A = B = C = D = OPEN, SGC = 0.78 V	-300	0	+300	mV
[COMP]			•	I	1		
Offset		V _{OSCO} 1	WO ₁ : WO ₁ = OPEN	-15	0	+15	mV

Test Circuit







Pin Functions

Pin No.	Pin	I/O	Function	Equivalent circuit
1	EQ _O	0	RF equalizer output	1 VCC 1 A11209
2	EQI	I	RF equalizer input	2
3	RF ₀ 2	0	RF output	(4) V _{CC} ≨10kΩ ↓ ↓ ↓ ↓ ↓ ↓
4	RF _I 1	I	RF AC coupled input	
5	RF ₀ 1	ο	RF AC coupled output	V_{CC} (5) (5) (5) $(20k\Omega)$ $(20k\Omega)$ (5) $(20k\Omega)$
6	RFV _{CC}	Р	RF block power supply	
7	J		I/V converted RF signal input	8 \$10kΩ 7 10kΩ \$56kΩ \$\$56kΩ \$7.5kΩ \$
8	I		I/V converted RF signal input	10kΩ 10kΩ 10kΩ 20kΩ 20kΩ 20kΩ 411213

Pin No.	Pin	I/O	Function	Equivalent circuit
9	V _{CC}	Р	Matrix block power supply	
10	V _C	0	1/2 V _{CC} output (reference voltage)	V_{CC} \downarrow \downarrow \downarrow \downarrow \downarrow \downarrow \downarrow \downarrow
11	V _R	I	1/2 V _{CC} input	1kΩ 1 25kΩ \$75Ω \$51kΩ # # (10 A11214
12 13	F E		Side beam signal inputs	(13) ↓
14 15 16 17	D C B A	I	Main beam signal inputs	$\begin{array}{c} 13 \\ 14 \\ 15 \\ 15 \\ 16 \\ 17 \end{array}$
18	LD _D	0	APC output	$\begin{array}{c ccccc} & & & & & \\ \hline 19 & & & & & \\ & & & & & & \\ & & & & & & \\ & & & & & & \\ & & & & & & \\ & & & & & & \\ & & & & & & \\ & & & & & & \\ & & & & & & \\ & & & & & & \\ & & & & & & \\ & & & & & & \\ & & & & & & \\ & & & & & & \\ & & & & & & \\ & & & & & & \\ & & & $
19	LD _D -	I	APC phase compensation capacitor connection	18 75Ωξ 90kΩ ↓ 75Ωξ 90kΩ ↓ μ ₹90kΩ ↓ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ μ
20	LDS		I/V converted laser optical intensity input	
24	LD _{REF}		Laser power setting input	24 <u></u>
21	V _{EE}	Р	Matrix block ground	
22	T _{BAL}	1	Tracking error signal balance adjustment voltage input	(22)
23	SGC	. 1	V _{CA} gain control voltage input (ground reference)	23KΩ

Pin No. Pin I/O Function Equivalent circuit 25 DSW0 I Disc mode switching signal input, laser off input. High: Low reflectance disc Low: High reflectance disc If both DSW0 and DSW1 are low, the laser is off. I I 26 DSW1 I Disc mode switching signal input, laser off input. High: Tracking is over a pit Low: Tracking is over a groove If both DSW0 and DSW1 are low, the laser is off. I I 27 FE O Focus error signal output I I 28 TE Tracking error signal output I I 29 CC1 I Defect peak hold signal AC coupled input I 29 CC1 I Defect peak hold signal AC coupled input I
25 DSW0 High: Low reflectance disc Low: High reflectance disc If both DSW0 and DSW1 are low, the laser is off. 26 DSW1 Disc mode switching signal input, laser off input High: Tracking is over a pit Low: Tracking is over a groove If both DSW0 and DSW1 are low, the laser is off. Image: Comparison of the pit state of the pit
26 DSW1 Disc mode switching signal input, laser off input High: Tracking is over a pit Low: Tracking is over a groove If both DSW0 and DSW1 are low, the laser is off. Image: Construction of the picture Image: Construle Image: C
$\begin{array}{c c c c c c c c c c c c c c c c c c c $
28 TE Tracking error signal output 29 CC1 I Defect peak hold signal AC coupled input $29 + 25k\Omega$ 29 CC1
29 CC_1 I Defect peak hold signal AC coupled input 1000000000000000000000000000000000000
V _{CC}
30 CP ₀ O Defect peak hold signal output 30 1kΩ
31 C_{DP} O Defect peak hold capacitor connection $31 \frac{\sqrt{CC}}{1k\Omega}$
32 V _{CC} P ADIP block power supply

Dia Na	Dir	1/0	Europhica.	Envirolant sinuit
Pin No.	Pin	I/O	Function	Equivalent circuit VCC
33	ABCD	ο	Main beam optical intensity signal output	33 50Ω 50Ω 50Ω 50Ω 50Ω 50Ω 50Ω 50Ω
				50kΩ ₹75Ω 50kΩ ₹75Ω ± ₹75Ω
34	HFL _{IN}	I	HFL detection optical intensity signal AC coupled input used in groove mode	34 60kΩ ₹100kΩ A11226
35	RF _{ENV}		RF envelope signal output	$35 \xrightarrow{V_{CC}} \xrightarrow{0}$
46	C _{HFL}	0	Mirror peak hold capacitor connection	46
36	HFL	0	HFL signal (tracking on/off signal) output	36

Pin No.					
37ADPCR0ADP carrier output 39 100 -10 100 38NC -1 No connection -100 39SETR1Bandpass filler fo setting 39 30 110 40WOQQVooble signal output 90 90 90 90 41WOQ1Vooble signal output 90 90 90 42DFQQDefect detection signal output 90 90 43PPITQPhigroove 90 90	Pin No.	Pin	I/O	Function	Equivalent circuit
39SETR1Bandpass filter fo setting40WO00Wobble signal output $\underbrace{\Psi_{CC}}_{\frac{1}{2750}}$ 41WO11Wobble signal AC coupled input $\underbrace{\Psi_{CC}}_{\frac{1}{2750}}$ 41WO11Wobble signal AC coupled input $\underbrace{\Psi_{CC}}_{\frac{1}{2750}}$ 42DF00Defect detection signal output $\underbrace{\Psi_{CC}}_{\frac{1}{150}}$ 43PPIT0Ptitgroove $\underbrace{\Psi_{CC}}_{\frac{1}{150}}$	37	ADIP _{CR}	ο	ADIP carrier output	(37)
39 SETR 1 Bandpass filter to setting 40 WO ₀ 0 Wobble signal output \sqrt{CC} (a) $\sqrt{T50}$ (c)	38	NC	_	No connection	
40WOo0Wobble signal output $if T S \Omega$ $T S \Omega$ $T S \Omega$ $T S \Omega$ 	39	SETR	I	Bandpass filter fo setting	
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	40	WO _O	0	Wobble signal output	$\begin{array}{c} 40 \\ 40 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ 1 \\ $
42DF00Defect detection signal output42 42 43PPIT0Pit/groove 43 11234	41	WOI	I	Wobble signal AC coupled input	1KΩ ≨50kΩ
43 PPIT O Pit/groove	42	DF _O	0	Defect detection signal output	(42)
44 V _{EE} P ADIP block ground	43	PPIT	ο	Pit/groove	(43)
	44	V _{EE}	Р	ADIP block ground	

Pin No.	Pin	I/O	Function	Equivalent circuit
45	CAD		Wobble DC cut capacitor connection	45 ↓ 300kΩ ↓ 1kΩ ↓ 300kΩ ↓ 1kΩ ↓ 1kΩ ↓ 1kΩ ↓ 1kΩ ↓ 1kΩ ↓ 1kΩ ↓ 1kΩ
47	RFV _{EE}	Р	RF block ground	
48	RF _I 2	I	RF signal input	48 30kΩ 30kΩ A11236

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